UK Patent Application (19) GB (11) 2 149 130 A

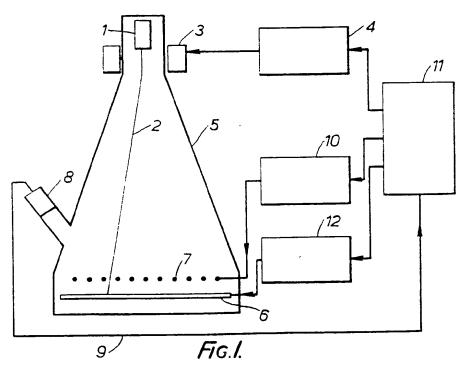
(43) Application published 5 Jun 1985

- (21) Application No 8427301
- (22) Date of filing 29 Oct 1984
- (30) Priority data (31) 8328912
- (32) 28 Oct 1983 (33) GB
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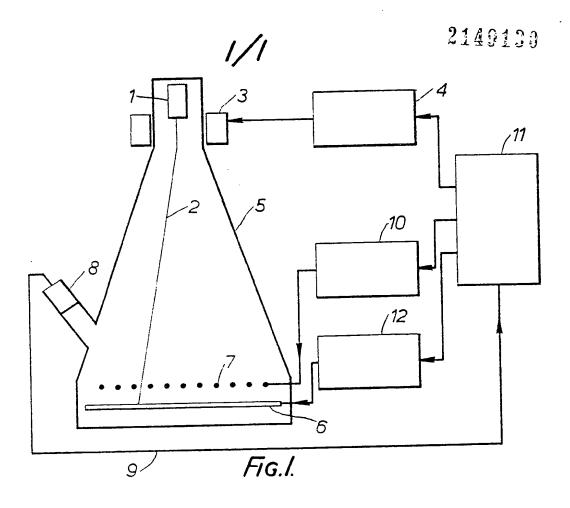
- (51) INT CL4 G01R 31/28
- (52) Domestic classification G1U C22
- (56) Documents cited None
- (58) Field of search G1U

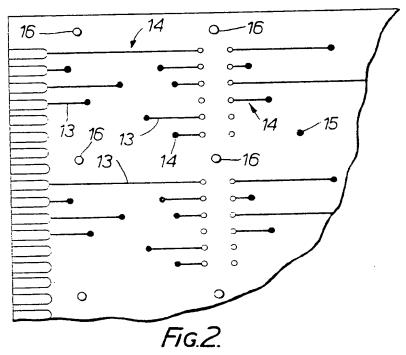
(54) Testing electronic circuits

(57) Electronic circuits mounted on substrates 6 are tested by directing a beam 2 of electrons successively at a plurality of points or locations of the circuit conductors (13, Fig. 2) and using the resulting secondary emission as the source of measurement signals. The test points may be points (14) of the circuit or pads of conductive material (15) provided on the substrate 6. To eliminate possible errors arising from the scanning and beam deflection geometry of the beam production apparatus 1, 3, 5, a plurality of reference pads or points (16) is provided on the substrate 6. In use, the beam deflection is effectively calibrated by directing the beam to the reference pads.



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SPECIFICATION

Testing electronic circuits

5 This invention relates to the testing of the operation of electronic circuits by the use of an electron beam.

UK Patent No. 1594597 discloses a method of testing electronic circuits in the 10 form of printed circuit boards having components mounted on them by directing a beam of electrons from an electron gun at a succession of test points on the circuit so as to produce a secondary emission of electrons 15 from each of these test points in turn. A potential barrier filter is provided adjacent the circuit under test. This barrier filter which is in the form of a grid maintained at a predetermined potential serves to produce a differenti-20 ation between the secondary emission from points of the circuit at a first potential as compared with the secondary emission from points of the circuit at a second potential. The electrons which penetrate the potential barrier 25 filter are accelerated to a scintillator so that light produced in the scintillator in response to the secondary electron emission can be detected by a photo multiplier detector. The electron beam is deflected in X and Y direc-30 tions by signals applied to deflection coils and in order to ensure that the electron beam scanning is correctly registered relative to the circuit under test, before a test sequence is started, the beam is swept over tooling marks 35 on the board and biasses for the X and Y

deflection coils are adjusted. This registration of the scanning relative to the circuit under test is useful in ensuring that the circuit has been correctly positioned in the 40 test apparatus but is unable to compensate for non-linearity in the deflection circuits dimensional variations between circuits under test, or deflections caused by magnetic fields generated by the circuit under test. Electron beam 45 scanning circuits are liable to produce pin cushion or barrel distortion over the scanned area. Hence although the circuit may be correctly positioned, as determined for example by the scanning of a mark at an edge of the 50 circuit, the tracking of the electron beam during its deflection across the circuit may, due to non-linearity in the deflection circuits, result in the beam being incorrectly directed at other parts of the circuit. This is especially 55 the case when circuits having relatively large dimensions are to be tested and hence require relatively large angles of deflection of the electron beam or in the case of very densly packed test points where the deflection angles 60 between test points are narrow. Also there may be dimensional variations during the manufacture of the printed circuit boards forming the circuit to be tested and this may result in a part of the circuit intended to be

65 impinged by the beam being located outside

the area of impingement of the beam. While it may be possible to decrease the non-linearity of the beam positioning by the use of costly and complex deflection circuits any improve-70 ment in the linearity of the beam positioning would not assist in overcoming a dimensional variation between circuits to be tested.

Furthermore it is believed that there may be variations in the secondary emission from the 75 circuit being tested as between conductors of different widths, due to very thin layers of undesired material covering the conductors, due to different parts of the circuit board being differently spaced from the potential 80 filter or due to differences in angle of impingement of the electron beam on different

parts of the circuit being tested.

According to the invention a method of testing an electronic circuit mounted upon a 85 substrate by directing a beam of electrons successively at a plurality of points or locations of the circuit at which it is desired to check, monitor or determine potentials in the circuit point or region to produce for each said 90 point or region a secondary electron current flow; filtering the secondary current flow by a potential barrier so that only secondary electrons at or above a predetermined potential level are passed to detection means, the 95 method including the steps of providing a plurality of reference points or locations distributed over an area or region of the substrate that is occupied by the electronic circuit and positioned in predetermined locations relative 100 to the circuit points or regions to be checked, monitored or otherwise determined.

Preferably the electron beam is caused to move to the vicinity of these reference points in succession and to scan the adjacent part of 105 the substrate to determine the locations of these reference points and successively modifting the deflection of the beam as the locaof the reference points are determined.

esired the respective locations of all or a 110 group of reference points may be determined prior to testing the potentials of points on the circuit or determination of the locations of the reference points may be carried out during a sequence of tests of the potentials of a plural-115 ity of points, the test of the potential at a point of the circuit being preceded by determination of the location of an adjacent reference point.

The reference points may be energised with 120 a steady predetermined potential or with signals such that secondary electron emission from each reference point provides data for controlling the deflection of the electron beam. The data may be utilised for setting the 125 potential filter to one or more different filtering levels during testing of the points on the circuits.

A method in accordance with the invention will now be described with reference by way 130 of example to the accompanying drawings in

which:

Figure 1 shows in schematic form, electron beam apparatus for testing potentials in an electronic circuit and

Figure 2 shows a circuit board for testing in the above apparatus.

Referring to Figure 1 an electron gun 1 generates a beam 2 of electrons which can be deflected in X or Y directions by coils 3 10 energised with deflection currents by deflection circuit 4 or by other deflection means, such as electrostatic deflection electrodes energised by a deflection circuit 4. The gun 1 is mounted in the narrow end of an enclosure 5 15 which can be evacuated and the wide end of the enclosure is constructed to permit the insertion and removal of a printed circuit board 6 to be tested. A mounting, not shown, is provided for the printed circuit board to 20 enable the board to be accurately positioned within the enclosure. Adjacent and parallel to the position occupied by a board under test are a number of grids for controllling secondary electrons emitted from the printed circuit 25 board when the electron beam impinges on the board. One of these grids 7 acts as a potential filter to secondary electrons such that emission from those portions of the circuit below a predetermined potential are pre-30 vented from reaching a detector 8 whereas the secondary emission from those portions of the circuit at or above that predetermined potential are permitted to pass to the detector and produce output signals on line 9. The 35 level of potential discrimination is determined by the potential applied by a potential source 10 to the grid 7. The deflection of the electron beam 2 by the deflection circuit 4 is controlled by a controller 11 which also con-40 trols the potential applied to the grid 7. During testing of a circuit 6, the circuit 6 is rendered operational and is caused to adopt appropriate functional states respectively by means of power potentials and input signals 45 applied by test circuit energiser 12 under the control of the controller 11.

Referring now to Figure 2 a printed circuit board consisting of one or more layers of conductors separated and supported by a sub-50 strate of insulating material, carried on one surface a plurality of conductors 13 connected to discrete components such as integrated circuits mounted on the opposite face of the board. In the test sequence, to which it is 55 desired to subject the printed circuit board, tests will be carried out at a plurality of points on the circuit to determine the potentials at those points. These points may be located on the conductors 13, for example, at positions 60 14, in some cases the points may be located on pads 15 of conductive material connected to the point in the circuit to be tested or in some cases at combinations of positions 14 and pads 15. Such pads may be required

65 where the potential of internal conductors is

to be tested.

In addition reference pads 16 of conductive material are provided distributed across the surface of the board. These pads are located at positions bearing fixed relationships with the points or locations 14, 15 to be tested or with groups of such points or locations. These reference pads 16 are utilised to provide a plurality of reference points or locations from which the positions of the points or locations to be tested can be determined.

A circuit board 6 to be tested is positioned in the enclosure 5 and is energised by appropriate power potentials and input signals by the test circuit energiser 12. The electron beam is deflected to a position within the vicinity of one of the reference pads 16 and then swept over a small area to produce an indication of the relative location of the pad 16. Signals obtained from this sweeping of the beam are utilised to bias the deflection circuit so as to centre the beam on the reference pad. The beam is then deflected by predetermined values in X and/or Y directions 90 to bring it into a first one of the points to be tested. After testing the potential at this point in the circuit the beam is again deflected by predetermined values relative to the first reference pad to bring it into the location of a second one of the reference pads. Providing the circuit board dimensions are correct and the deflection circuit is sufficiently linear, the beam will be centred on this pad. However, if the beam is not so aligned, a small sweep of 100 an area is affected whereby the beam is utilised to detect the reference pad and generate new correction factors for the deflection. This second reference pad is then used as the base for deflecting the beam to the next point

105 to be tested. If desired the beam may be swept over the area of each of the test points so that if the area of any test point is partially contaminated acceptable signals are produced from the un-110 contaminated portion.

The reference pads may also be utilised to provide control signals on line 9 to the controller 11 to very the discrimination potential of the grid 7. For example the reference pad 115 may be energised to the potential at which it is desired to maintain the grid 7 in respect of tests on points adjacent that pad. Hence when the beam has been centred on the pad, the controller 11 carried out the step of adjusting 120 the potential of the grid 7 and only then is the beam moved to the point to be tested. The above described adjustment of the discrimination potential of the grid 7 may be used to compensate for variation in the secondary 125 emission from different test points on the circuit. Such variations may arise due to different widths of the conductors or pads at which the test points are located, or the

presence of undesired mat rial overlying the

130 test points at some parts of the circuit or

differences in the spacing of different parts of the circuit board and the grid 7.

CLAIMS

- 1. A method of testing an electronic circuit mounted upon a substrate by directing a beam of electrons successively at a plurality of points or locations of the circuit at which it is desired to check, monitor or determine poten-10 tials in the circuit point or region to produce for each said point or region a secondary electron current flow; filtering the secondary current flow by a potential barrier so that only secondary electrons at or above a predeter-
- 15 mined potential level are passed to detection means, the method including the steps of providing a plurality of reference points or locations distributed over an area or region of the substrate that is occupied by the elec-
- 20 tronic circuit and positioned in predetermined locations relative to the circuit points or regions to be checked, monitored or otherwise determined.
- 2. A method as claimed in claim 1 and 25 including the steps of causing the electron beam to scan the substrate to determine the locations of the reference points or locations and successively modifying, where necessary, the deflection parameters for the electron 30 beam as the positions of the reference points
 - or locations are determined. 3. A method as claimed in claim 1 or 2, and in which the respective positions of all or a group of the reference points are deter-

35 mined prior to the effecting of the testing of

the potentials on the circuit.

- 4. A method as claimed in claim 1 or 2. and in which the determination of the positions of the reference points or locations is 40 carried out during a sequence of testing of the potentials of a plurality of points or locations, the test of a potential at a point of the circuit being preceded by determination of the location of an adjacent reference point.
- 5. A method as claimed in any one of 45 claims 1 to 4, and in which the reference points are energised by a steady predetermined potential.
- 6. A method as claimed in any one of 50 claims 1 to 4, and in which the reference points are energised with signals such that the secondary electron emission from each reference point provides data for controlling the deflection characteristic of the electron beam.
- 7. A method as claimed in claim 6, and in which the data is utilised for setting the means for filtering the secondary current flow to one or more different filtering levels during the testing of the reference points of the
 - 8. A method as claimed in any one of claims 1 to 7, and in which the reference points comprise conductive pads and the like on the substrate.
 - 9. A method as claimed in any one of

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- claims 1 to 7, and in which the refer nce points comprise sel ct d regions of the printed circuit on the substrate.
- 10. A method as claimed in any one of 70 claims 1 to 7, and in which the reference points include pads or the like on the substrate and selected regions of the printed circuit on the substrate.
- 11. A method of testing an electronic cir-75 cuit mounted on a substrate substantially as hereinbefore described with reference to the drawings.

Printed in the United Kingdom for Her Majesty's Stationery Office, Dd 8818935, 1985, 4235. Published at The Patent Office, 25 Southampton Buildings, London, WC2A 1AY, from which copies may be obtained.